

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

Assignment ID: PATI398026

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	NOTICE OF GRANT OF SECURITY INTEREST IN U.S. PATENTS
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
AmeriTi Manufacturing, LLC	07/31/2024
SCM Metal Products, Inc.	07/31/2024
<b>RECEIVING PARTY DATA</b>	
<b>Company Name:</b>	HPS INVESTMENT PARTNERS, LLC, as Administrative agent and Collateral agent
<b>Street Address:</b>	40 West 57th Street, 33rd Floor
<b>City:</b>	New York
<b>State/Country:</b>	NEW YORK
<b>Postal Code:</b>	10019
<b>PROPERTY NUMBERS Total: 3</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15852211
<b>Application Number:</b>	17374955
<b>Application Number:</b>	17855061
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	2028357507
<b>Email:</b>	jramos@milbank.com,dcip@milbank.com
<b>Correspondent Name:</b>	Javier J. Ramos
<b>Address Line 1:</b>	1850 K Street, NW, Suite 1100
<b>Address Line 4:</b>	Washington, DISTRICT OF COLUMBIA 20006
<b>ATTORNEY DOCKET NUMBER:</b>	34408.00142
<b>NAME OF SUBMITTER:</b>	JAVIER RAMOS
<b>SIGNATURE:</b>	JAVIER RAMOS
<b>DATE SIGNED:</b>	08/15/2024
<b>Total Attachments: 5</b>	
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**PATENT**

**REEL: 068630 FRAME: 0224**

## NOTICE OF GRANT OF SECURITY INTEREST IN U.S. PATENTS

This NOTICE OF GRANT OF SECURITY INTEREST IN U.S. PATENTS (the “IP Security Agreement”) dated as of July 31, 2024, is made by the Persons listed on the signature pages hereof (collectively, the “Grantors” and individually, each a “Grantor”) in favor of HPS INVESTMENT PARTNERS, LLC, as administrative agent and collateral agent (in such capacities and together with any successors and assigns in such roles, the “Administrative Agent”) for the Secured Parties (as defined in the Term Loan Credit Agreement referred to below).

WHEREAS, Alchemy US Holdco 1, LLC, a Delaware limited liability company, Alchemy US Intermediate Holdco, LLC, a Delaware limited liability company, Kymera International, LLC, a Delaware limited liability company, each lender from time to time party thereto (collectively, the “Lenders” and individually, each a “Lender”) and the Administrative Agent have entered into a Term Loan Credit Agreement dated as of the date hereof (as amended, restated, amended and restated, supplemented, replaced, refinanced or otherwise modified from time to time (including any increases of the principal amount outstanding thereunder), the “Term Loan Credit Agreement”);

WHEREAS, as a condition precedent to the making of the Loans by the Lenders from time to time, each Grantor has executed and delivered that certain U.S. Security Agreement dated as of July 31, 2024 among the Grantors and the Administrative Agent (as amended, restated, amended and restated, supplemented or otherwise modified from time to time, the “Security Agreement”); and

WHEREAS, under the terms of the Security Agreement, the Grantors have granted to the Administrative Agent, for the benefit of the Secured Parties, a security interest in, among other property, certain intellectual property of the Grantors, and have agreed thereunder to execute this IP Security Agreement for recording with the United States Patent and Trademark Office, the United States Copyright Office.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each Grantor agrees as follows:

Section 1. Definitions. Capitalized terms used in this IP Security Agreement and not otherwise defined herein shall have the meanings ascribed to such terms in the Term Loan Credit Agreement or the Security Agreement, as applicable.

Section 2. Grant of Security. As security for the payment or performance, as the case may be, in full, of the Secured Obligations, each Grantor hereby grants to the Administrative Agent, for the benefit of the Secured Parties, a security interest in all of such Grantor’s right, title and interest in and to the following to the extent governed by, arising under, pursuant to, or by virtue of, the Laws of the United States of America or any state thereof (the “Collateral”):

all patents and patent applications, including the inventions and improvements described and claimed therein together with the reissues, divisions, continuations, renewals, extensions and continuations in part thereof, all income, royalties, damages and payments now or hereafter due and/or payable with respect thereto, all damages and payments for past or future infringements thereof and rights to sue therefor, and all rights corresponding thereto throughout the world (“Patents”);

all registrations and applications for registration for any of the foregoing in the United States Patent and Trademark Office, including, without limitation, the registrations and applications for registration of United States intellectual property set forth in Schedule I hereto, together with all reissues, divisions, continuations, continuations-in-part, extensions, renewals and reexaminations thereof; and

any and all claims for damages and injunctive relief for past, present and future infringement, dilution, misappropriation, violation, misuse or breach with respect to any of the foregoing, with the right, but not the obligation, to sue for and collect, or otherwise recover, such damages;

*provided*, that notwithstanding anything to the contrary contained in the foregoing clauses (a) through (c), the security interest created hereby shall not extend to, and the term "Collateral" shall not include, any Excluded Assets.

Section 3. Security for Obligations. The grant of a security interest in the Collateral by each Grantor under this IP Security Agreement secures the payment of all Secured Obligations of such Grantor now or hereafter existing under or in respect of the Loan Documents (as such Loan Documents may be amended, restated, amended and restated, supplemented, replaced, refinanced or otherwise modified from time to time (including any increases of the principal amount outstanding thereunder)).

Section 4. Recordation. Each Grantor authorizes and requests that the Commissioner for Patents and any other applicable government officer record this IP Security Agreement with the United States Patent and Trademark Office.

Section 5. Execution in Counterparts. This IP Security Agreement may be executed in any number of counterparts, each of which when so executed shall be deemed to be an original and all of which taken together shall constitute one and the same agreement. Delivery of an executed counterpart of a signature page to this IP Security Agreement by facsimile or in .pdf or similar format by electronic mail shall be effective as delivery of an original executed counterpart of this IP Security Agreement.

Section 6. Grants, Rights and Remedies. This IP Security Agreement has been entered into in conjunction with the provisions of the Security Agreement. Each Grantor does hereby acknowledge and confirm that the grant of the security interest hereunder to, and the rights and remedies of, the Administrative Agent with respect to the Collateral are more fully set forth in the Security Agreement, the terms and provisions of which are incorporated herein by reference as if fully set forth herein. In the event of any conflict between the terms of this IP Security Agreement and the terms of the Security Agreement, the terms of the Security Agreement shall govern.

Section 7. Governing Law. This IP Security Agreement shall be governed by, and construed in accordance with, the law of the State of New York.

[Remainder of the page intentionally left in blank.]

**IN WITNESS WHEREOF**, the Grantors and the Administrative Agent have caused this IP Security Agreement to be duly executed and delivered by its officer thereunto duly authorized as of the date first written above.

**GRANTORS:**

**AMERITI MANUFACTURING, LLC  
SCM METAL PRODUCTS, INC.**

By: \_\_\_\_\_  
Name: Mark McClanahan  
Title: Chief Financial Officer

*[Signature Page to Notice of Grant of Security Interest in U.S. Patents]*

**PATENT  
REEL: 068630 FRAME: 0227**

**HPS INVESTMENT PARTNERS, LLC, as**  
Administrative Agent

By: 

Name: Daniel Wang

Title: Managing Director

*[Signature Page to Notice of Grant of Security Interest in U.S. Patents]*

**PATENT**  
**REEL: 068630 FRAME: 0228**

**Schedule I  
PATENTS**

<u>Grantor</u>	<u>Jurisdiction</u>	<u>Application Number</u>	<u>Application Date</u>	<u>Title</u>	<u>Patent Number/ {Publication No.}</u>	<u>Issue Date/ Publication Date</u>	<u>Status</u>
AmeriTi Manufacturing, LLC	United States	15/852,211	12/22/2017	DEOXIDATION OF METAL POWDERS	11077497	8/3/2021	Issued
AmeriTi Manufacturing, LLC	United States	17/374,955	7/13/2021	DEOXIDATION OF METAL POWDERS	{US 2021-0339313 A1}	11/4/2021	Published
SCM Metal Products, Inc.	United States	17/855061	06/30/2022	COMPOSITE CORED WIRE CLADDING	{US 2023-0097681 A1}	3/30/2023	Published

**PATENT**

**REEL: 068630 FRAME: 0229**

**RECORDED: 08/15/2024**